Province, China.

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SPECIFICATION FOR APPROVAL

CUSTOMER CUST. PART NO) .
CUST. DOC. RE DESCRIPTION SAMPLE LOT N	POWER CHOKE(RoHS+H.F.)
PART NO.	CSMS2012D-XXXX-LRH
DOC. REV.	
DATE	
Once you approve this part, please s	sign and return this page to the following marked location.
Customer Signature:	PSA Date:
☐This part currently development section Sales Office-Headquarter	on. Production line can produce this series of products. Yong Zhou Plant
No. 566-1, Kao-Shi Rd., Yangmei, Taoyi Taiwan TEL: +886-3-475-3355 FAX: +886-3-485-4959	
☐Sales Office-Dong Guan,China No.638,Mei Jing West Road Xiniupo Ad Zone Dalang Town,Dong Guan City,Gu	

TESTED BY	CHECKED BY	APPROVED BY

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	SPECIFICATION			L	
CUSTOMER	CUSTOMER P/N	REV.	SPL. LOT NO.		
		_			
PART NAME	PART NO.	REV.	DATE OF ISSUE	Q'TY	
POWER CHOKI (ROHS+H.F.)	CSMS2012D-XXXX-LRH				0 PCS
	GINEERING CHAN	GE NC	TICE - REC	CORD	
REVISION NO.	REVISION DESCRIPTION	N	AUTHOR	DATE	REMARK
	OPPROSPERITY DIE	股份高 Hectrics RICS CO., LTD	SHIS PESEN		

※This is a RoHS and REACH compliant product whose related documents are available on request.

XGraphic is only for dimensionally application.

1. Range of application:

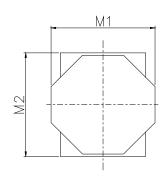
This specifications are applied to SMD Power Inductor, CSMS2012D.

2. Ordering code:

Example: $\frac{CSMS}{(1)}$ $\frac{2012}{(2)}$ $\frac{D}{(3)}$ $\frac{M}{(4)}$ $\frac{D}{(5)}$ $\frac{D}{(6)}$

- (1) Product Type
- (2) External dimensions
- (3) Solder Type
- (4) Inductance
- (5) Inductance tolerance
- (6) Green product code
- (7) Internal Code

3. Mechanical Dimension:

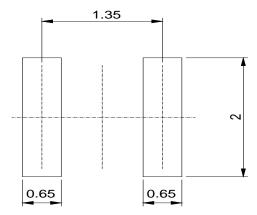




UNIT: mm

	DIM.	TOL.
M1	2.0	±0.1
M2	2.0	±0.1
М3	1.2	MAX.
M4	0.5	±0.2
M5	1.25	±0.2

4. Recommended Land-Pattern:



(Unit: mm)

5. Electrical Characteristics:

Part number		Inductance	DC Resistance	Rated Current (mA)			
	Tolerance	(Ω) ±20%	Saturation Current Idc1 (Typ.)	Temperature Rise Current Idc2 (Typ.)	Saturation Current Idc1(Max.)	Temperature Rise Current Idc2(Max.)	
CSMS2012D-1R0N-LRH	1.0	±30%	0.070	2050	1850	1900	1700
CSMS2012D-1R5N-LRH	1.5	±30%	0.090	1800	1650	1650	1500
CSMS2012D-2R2M-LRH	2.2	±20%	0.107	1500	1500	1350	1370
CSMS2012D-3R3M-LRH	3.3	±20%	0.190	1150	1100	1000	1020
CSMS2012D-4R7M-LRH	4.7	±20%	0.241	1050	1000	900	910

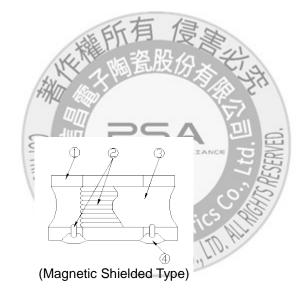
- 1. Test Frequency: 100KHz
- 2. Test Equipment:

Inductance: Chroma3302+1320+16502. or equivalent.

DCR: Chroma16502 or equivalent.

- 3. Saturation Current Idc1: The value of current causes a 30% inductance reduction from initial value.
- 4. Temperature rise current ldc2: The value of current causes a 40° C temperature rise.
- 5. Rated Current: Either Idc1 or Idc2 whichever is smaller.
- 6. Operating Temperature Range:-25°C to +120°C (Including self-temperature rise)
- 7. Storage Temp. Range : -40° C to $+85^{\circ}$ C.
- 8. MSL: Level 1

6. Structural Drawing:



① Ferrite core Ni-Zn ferrite

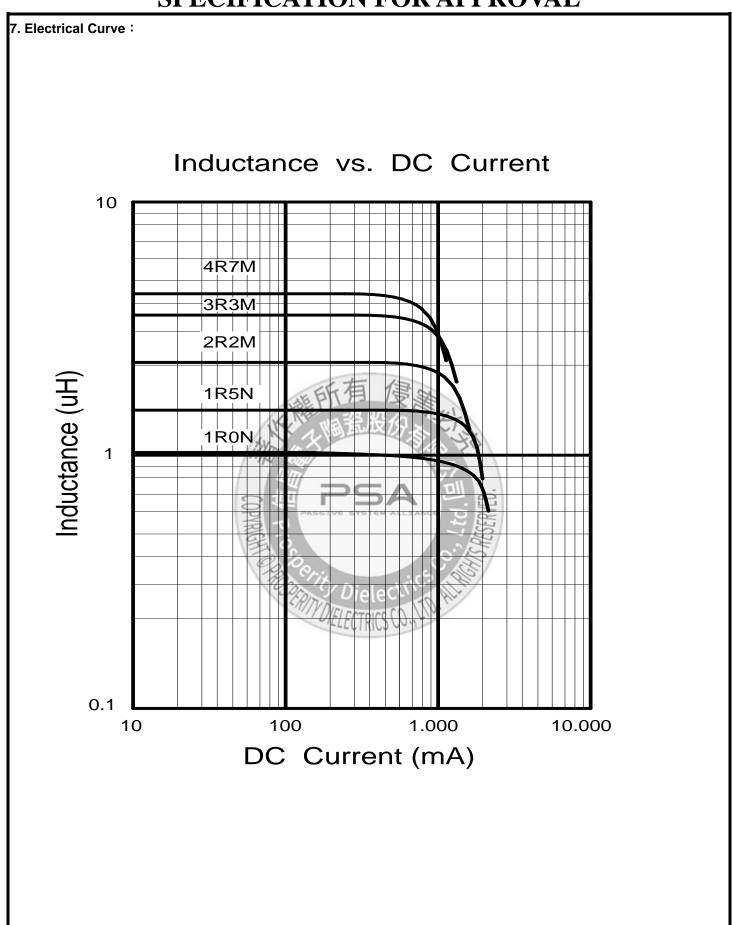
② Winding wire Polyurethane-copper wire

③ Over-coating resin Epoxy resin, containing ferrite powder

④ Electrode External electrode (substrate)

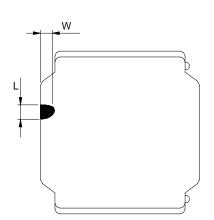
External electrode (base plating) Ni-Sn External electrode (top surface solder coating) Sn-Ag-Cu

P4 Rev.A



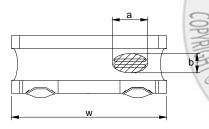
8. Core Chipping:

The appearance standard of the chipping size in top side, of bottom side ferrite Core is following dimension



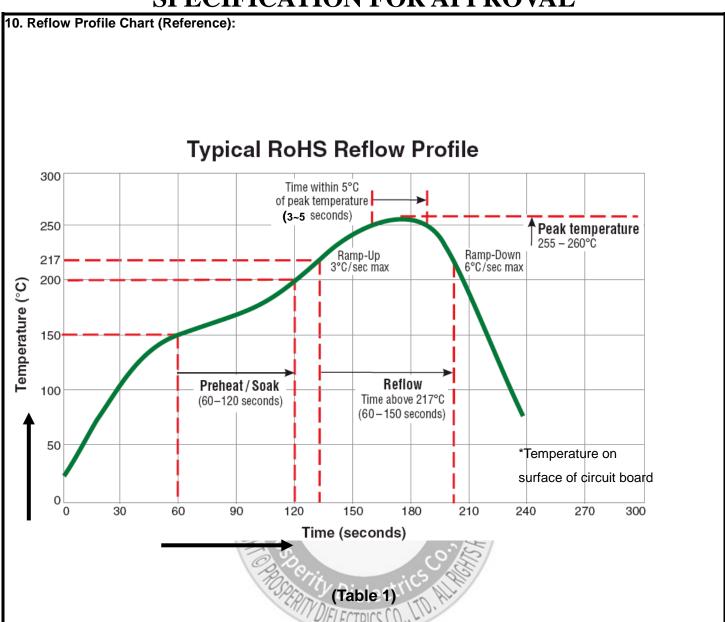
L	W		
0.4mmMax.	0.4mmMax.		

Exposed wire tolerance limit of coating resin part on product side Size of exposed wire occurring to coating resin is specified below.



- ① Width direction (dimension a): Acceptable when a<=w/2
 Nonconforming when a>w/2
- ② Length direction (dimension b): Dimension b is not specified.
- ③ When total area of exposed wire occurring to each sides is not greater than 50% of coating resin area, that is acceptable.

Dielectrics Co., LTD. H

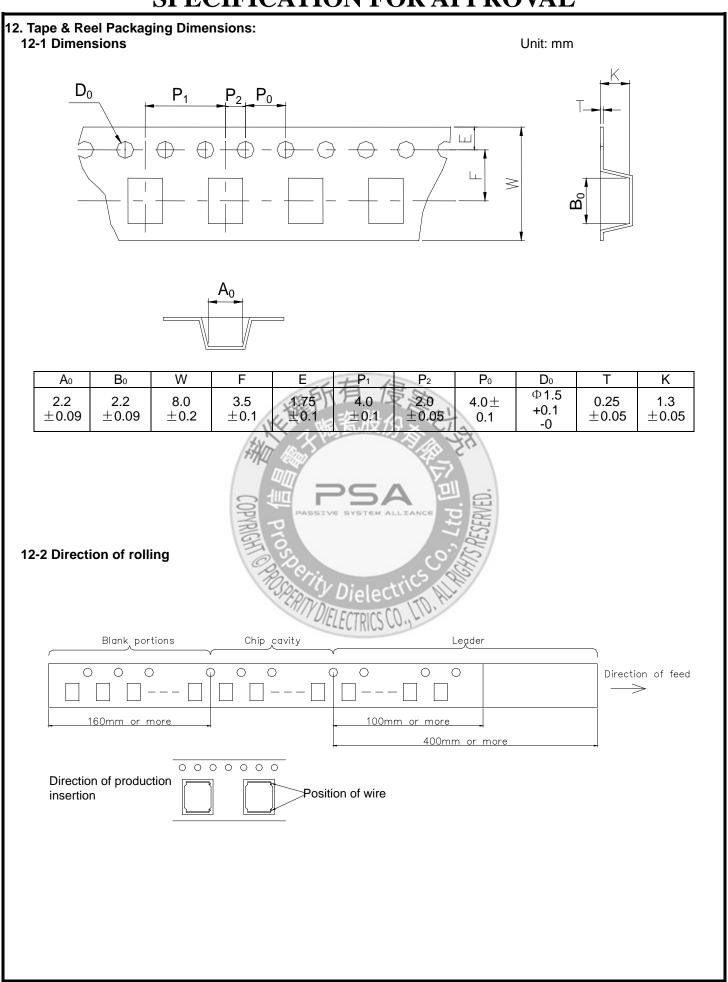


The products may be exposed to reflow soldering process of above profile up to two times.

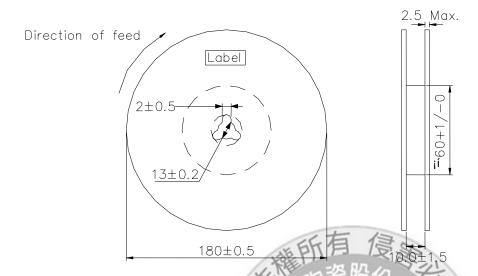
	Test Item	Standard	Test method	
	Deflection		The test samples shall be soldered to the test board by the reflow soldering conditions show in Table 1. As illustrated below, apply force in the direction of the Arrow indicating until deflection of the test board Reaches to 2 mm.	
			Force R230 5.1	
STICS			R5 Board Test Sample 45±2 45±2 1.5	4.0
ERIG		1	Land dimensions	
CT			Test board size:100×40×10	
R			Test board material I: glass epoxy-resin Solder cream thickness:0.1 Unit:	t: mm
MECHANICAL CHARACTERISTICS	Adhesion of Terminal Electrode	Shall not come off PC board	The test samples shall be soldered to the test board By the reflow soldering conditions shown in Table 1.	
ME		COPYRIGHT	Applied force:10 N to X and Y directions Duration:5 s. Solder cream thickness:0.1 mm (Refer to recommended Land Pattern Dimensions Defined in "Precaution")	
	Body strength	No damage		

Test Item	Standard		Test method	
Resistance to	△L/L:within±10%	The test samples shall be soldered to the test board by The reflow soldering conditions shown in Table 1.Then		ble 1.Then
Vibration	No abnormality		o below test conditions	S
	observed	Frequency range 10		a a a la vation
	In appearance	19 19 19	5mm(May not exceed 96 m/S ²)	
			OHz to 55Hz to 10 Hz f	
		Time Fo	or 2 hours on each X,\	7, and ∠ axis.
Resistance to	△L/L:within±10%	230±5 deg C for 40 se	be exposed to reflow econds, with peak tem	
Soldering heat	No abnormality	260±5 deg C for 5 se	econds, 2 times.	
(Reflow)	observed	Test board thickness:		
	In appearance	Test board material :g	•	
Solder ability	At least 90% of surface	Immersed in molten s	Il be dipped in flux, an older as shown in belo	ow table.
	of terminal electrode is	_	on containing rosin 259	% T
	covered by new solder.	Solder Temperature	-	_
	VE	有Time	5±1.0 S.	1
	楼里	Immersing Speed	25 mm/s	
Temperature Characteristics	△L/L:within±20% No abnormality observed In appearance	Range within -25 deg With reference to indu Rate shall be calculat	uctance value at +20 d ed.	leg C, change
Thermal shock	△L/L:within±10% No abnormality observed In appearance	By the reflow solderin The test samples sha Shown in below table	e shall be repeated 10	Table 1. ed
	SPERIN	Step Tempera	ture Time(m	in)
		11 C -40±3 de		
		2 Room Te	emp 3 maxim	ium
		3 85±2 deg	g C 30±3	
		4 Room Te	emp 3 maxim	ium
Low Temperature life Test	△L/L:within±10% No abnormality observed In appearance	The reflow soldering of	Il be soldered to the te conditions shown in Ta mples shall be placed a in below table.	ıble 1.
		Temperature	-40±2 deg C	
		Time	500 +24/-0 h	

	Test Item	Standard	Test method
	Loading at high temperature life test	△L/L:within±10% No abnormality observed in appearance.	The test samples shall be soldered to the test board by the reflow soldering conditions shown in Table 1. The test samples shall be placed in thermostatic oven set at specified temperature and applied the rated current continuously as shown in below table.
			Temperature 85±2 deg C
			Applied current (Refer to Page 2)
			Time 500+24/-0 h
ENVIRONMENT TESTS	Damp heat life test	△L/L:within±10% No abnormality observed in appearance.	The test samples shall be soldered to the test board by the reflow soldering conditions shown in Table 1. The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table. Temperature 60±2 deg C
ME		/.6	Humidity 90~95%RH
NO.		大道	Time 500+24/-0 h
ENVIR		ALT RES	風瓮股份亦無對
	Loading under Damp heat life test	△L/L:within±10% No abnormality observed in appearance.	The test samples shall be soldered to the test board by the reflow soldering conditions shown in Table 1. The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table. Temperature 60±2 deg C Humidity 90~95%RH Applied current (Refer to Page 2)) Time 500+24/-0 h

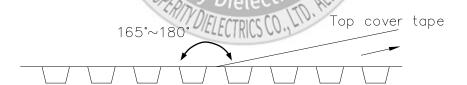


12-3 Reel



Label position:on the opposite sie of sprocket holes side of reel

12-4 Top tape strength

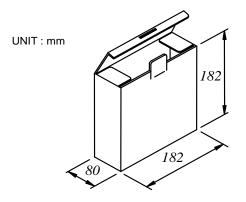


Peel-off strength: 0.1N~0.7N

Peel-off angle:165°~180°

Peel-off speed: 300mm/mm

12-5 Dimensions of packing box (for Tape & Reel package)



CONSTURCTION:

THE CASE CONTAINS 5-8mm $\,$ WIDE CARRIER TAPES.

Q'TY: 2,500/ REEL



TOTAL Q'TY: 75,000 PCS